UNIKC Semiconductor

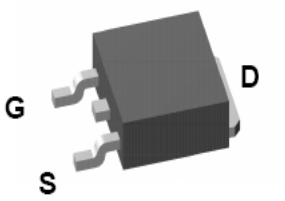
RoHS Compliant

P0703ED

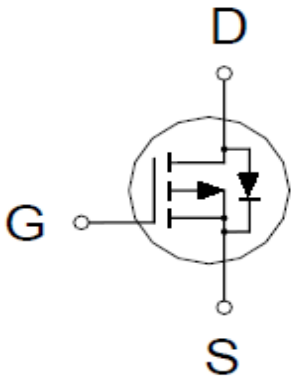
P-Channel Logic Level Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
-30V	7.5mΩ @V_{GS} = -10V	-68A



TO-252



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	±25	V
Continuous Drain Current[2]	T_C= 25 °C	I_D	-68	A
	T_C= 100 °C		-43	
Pulsed Drain Current[1]		I_{DM}	-160	
Avalanche Current		I_{AS}	-65	
Avalanche Energy	L=0.1mH	E_{AS}	214	mJ
Power Dissipation	T_C= 25 °C	P_D	60	W
	T_C= 100°C		24	
Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		2.08	°C / W

[1]Pulse width limited by maximum junction temperature.

[2]The maximum current rating is package limited.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS MIN	LIMITS TYP	LIMITS MAX	UNITS
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = -250μA	-30			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250μA	-1	-1.4	-3	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±16V			±30	μA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} =-24V, V_{GS} = 0V			1	μA
		V_{DS} =-20V, V_{GS} = 0V, T_J = 125°C			10	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = -5V, V_{GS} = -10V	-160			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} =-4.5V, I_D =-20A		6	12	mΩ
		V_{GS} =-10V, I_D =-20A		4	7.5	
Forward Transconductance[1]	g_{fs}	V_{DS} =-5V, I_D =-20A		58		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = -15V, f = 1MHz		5110		pF
Output Capacitance	C_{oss}			995		
Reverse Transfer Capacitance	C_{rss}			850		
Gate Resistance	R_g	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz		2.7		Ω
Total Gate Charge[2]	Q_g V_{GS} = -10V	V_{DS} =-15V, I_D = -20A		118		nC
	Q_g V_{GS} =-4.5V			61		
Gate-Source Charge[2]	Q_{gs}			12		
Gate-Drain Charge[2]	Q_{gd}			30		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DS} =-15V ,I_D ≅ -20A, V_{GS}=-10V,R_{GS}=6Ω		32		nS
Rise Time[2]	t_r			24		
Turn-Off Delay Time[2]	$t_{d(off)}$			90		
Fall Time[2]	t_f			44		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I_S				-46	A
Forward Voltage[1]	V_{SD}	I_F = -10A, V_{GS} = 0V			-1.3	V
Reverse Recovery Time	t_{rr}	I_F = -20A, dI_F/dt = 100A / μS		33		nS
Reverse Recovery Charge	Q_{rr}			17		nC

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

[2]Independent of operating temperature.

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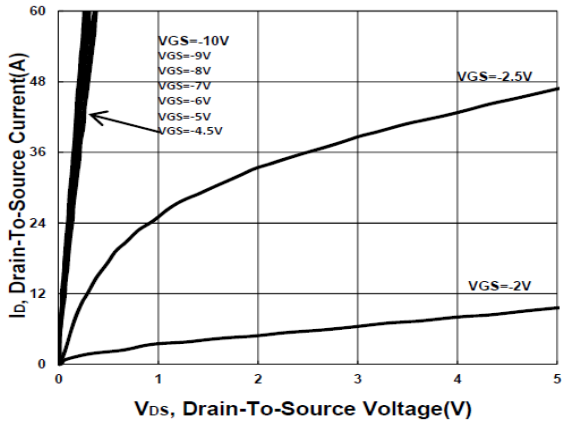
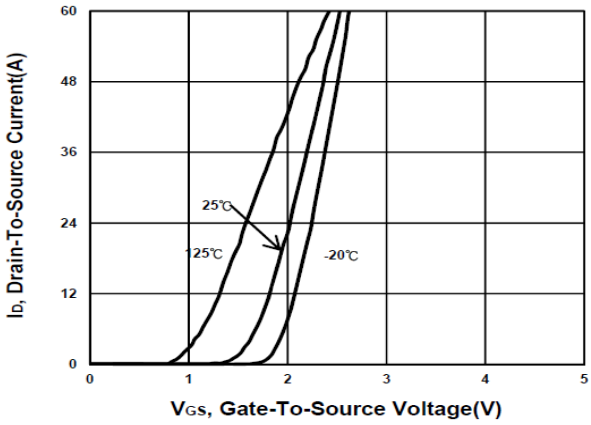
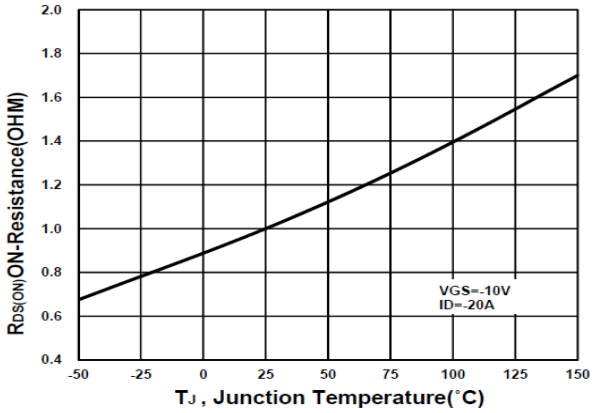
Output Characteristics



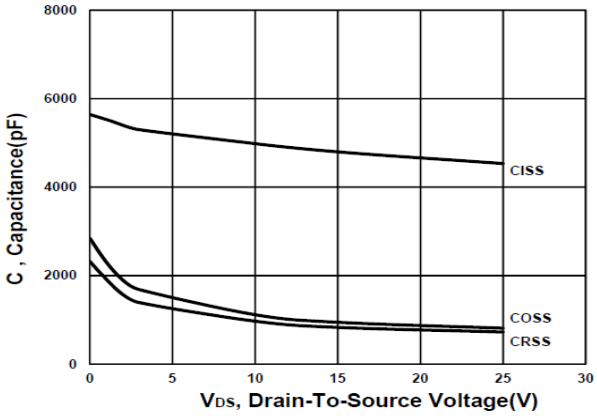
Transfer Characteristics



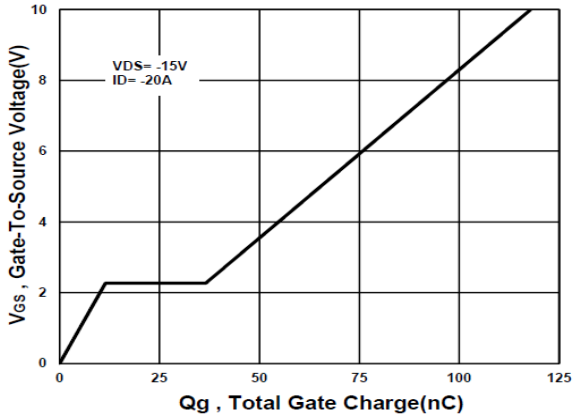
On-Resistance VS Temperature



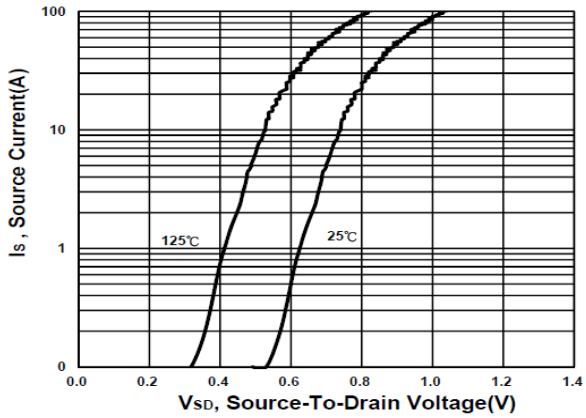
Capacitance Characteristic



Gate charge Characteristics



Source-Drain Diode Forward Voltage



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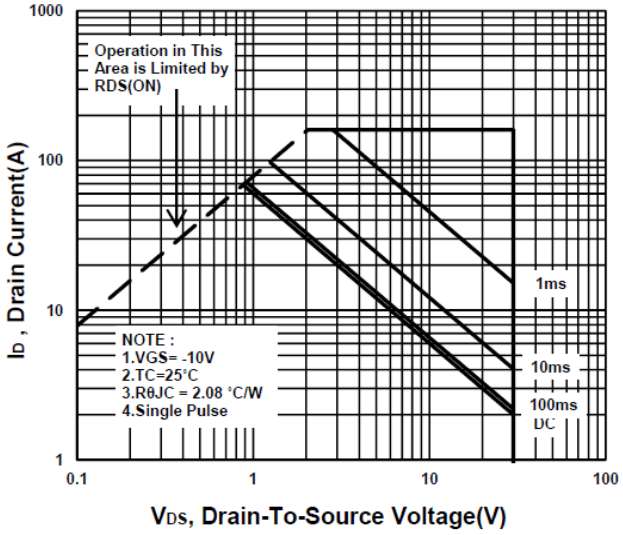
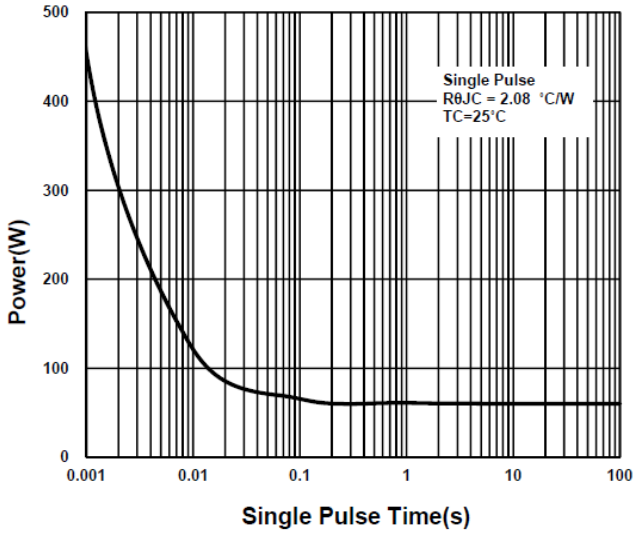
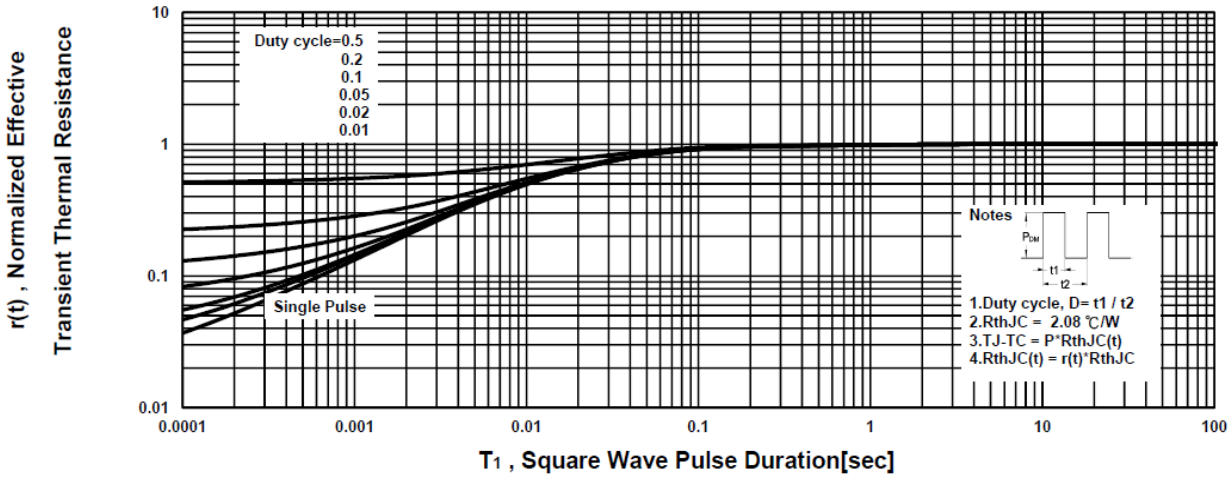
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



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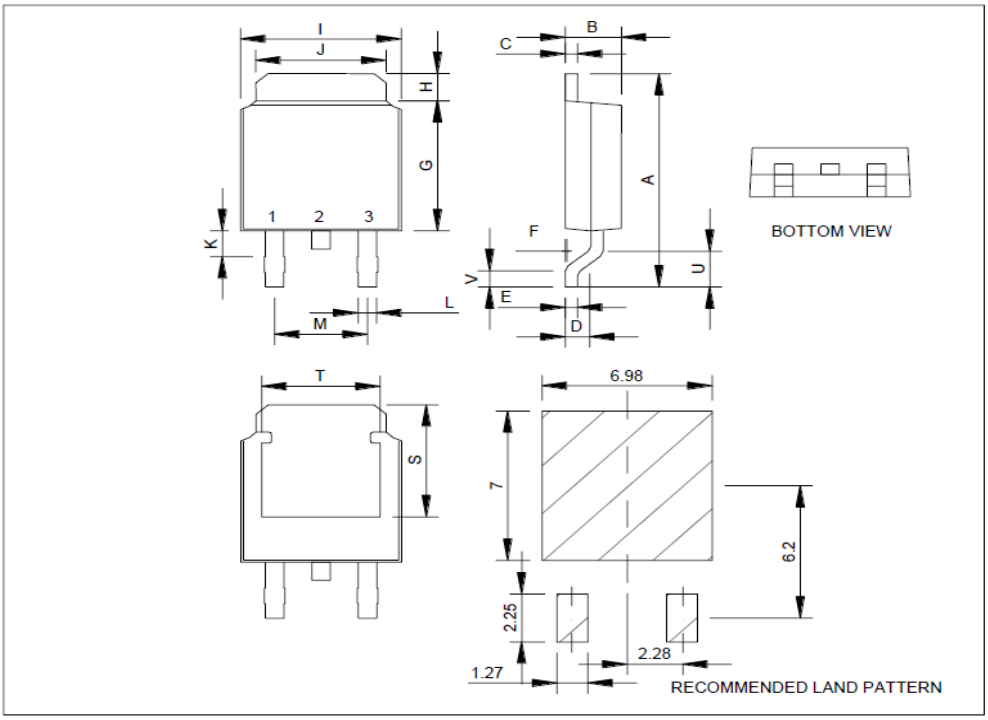
Package Dimension

TO-252 (DPAK) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	8.9	10	10.41	J	4.8		5.64
B	2.1	2.2	2.4	K	0.15		1.1
C	0.4	0.5	0.61	L	0.4	0.76	0.89
D	0.82	1.2	1.5	M	4.2	4.58	5
E	0.4	0.5	0.61	S	4.9	5.1	5.3
F	0		0.2	T	4.6	4.75	5.44
G	5.3	6.1	6.3	U	1.4		1.78
H	0.9		1.7	V	0.55	1.25	1.7
I	6.3	6.5	6.8				



*因为各家封装模具不同而外观略有所差异，不影响电性及Layout。